3A High Voltage Synchronous Buck Converter

PRODUCTION DATA SHEET

DESCRIPTION

NX7102 is a 340kHz fixed frequency, current mode, PWM synchronous buck (step-down) DC-DC converter, capable of driving a 3A load with high efficiency, excellent line and load regulation. The device integrates N-channel power MOSFET switches with low on-resistance. Current mode control provides fast transient response and cycle-by-cycle current limit.

The controller is equipped with output over-voltage protection which protects the IC under an open load condition. Additional safety features include under voltage lock-out (UVLO), programmable soft-start and over-temperature protection (OTP) to protect the circuit.

This IC is available in SOIC-8 with exposed pad package.

KEY FEATURES

- 3A Synchronous Step-down Regulator
- Operational Input Supply Voltage Range: 4. 5V-18V
- Integrated Upper NMOS and Lower NMOS
- 340kHz Switching Frequency
- Input UVLO
- Enable
- Programmable External Soft-Start
- Cycle-By-Cycle Over-Current Protection
- Over Voltage Protection
- Frequency Fold Back Under Short Condition

APPLICATIONS

- Set-Top Box
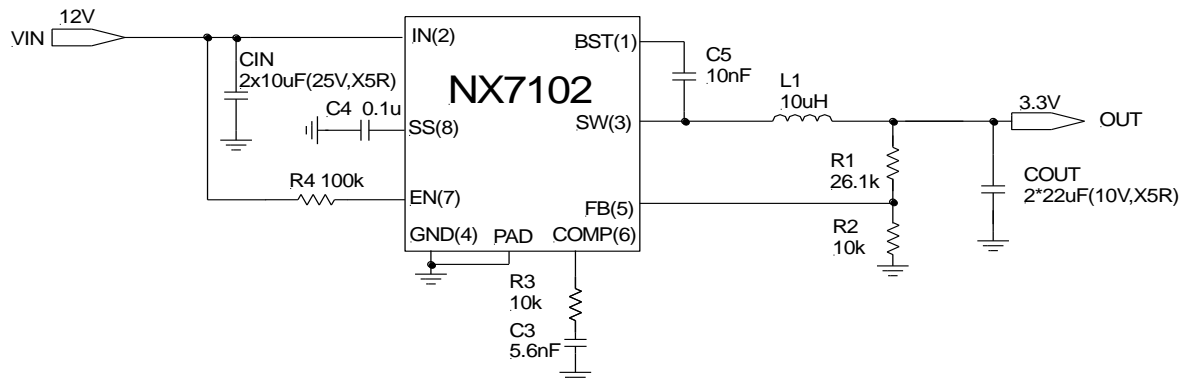- LCD TV's
- Notebook/Netbook
- PoE Powered Devices

PRODUCT HIGHLIGHT

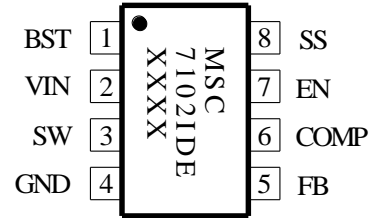**Figure 1 –** 12V Input, 3.3V Output with Ceramic Cap

PACKAGE ORDER INFO

T$_A$ (°C)	DE	Plastic SOIC 8 Pin With Exposed Pad
		RoHS Compliant / Pb-free
-40 to 85		**NX7102IDE**

Note: Available in Tape & Reel. Append the letters "TR" to the part number. (i.e. NX7102IDE-TR)

Copyright © 2010
Rev.1.6, 2015-02-20

Microsemi
Analog Mixed Signal Group
One Enterprise, Aliso Viejo, CA, 949-380-6100, Fax: 949-215-4996

Page 1

www.*Microsemi*.com

ABSOLUTE MAXIMUM RATINGS

Supply Input Voltage (VIN)... -0.3V to 20V
Switch Voltage (SW) .... -1V to (VIN + 1V)
EN .... -0.3V to (VIN + 0.3V)
BST ....-0.3V to (VSW + 6V)
COMP, FB, SS .... -0.3V to 6V
Maximum Operating Junction Temperature.. 150°C
Storage Temperature Range ....-65°C to 150°C
Package Peak Temp. for Solder Reflow (40 seconds maximum exposure)................ 260°C

Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to
        Ground. Currents are positive into, negative out of specified terminal.

PACKAGE PIN OUT

```
BST  [1        •        8]  SS
                M
VIN  [2    7   S        7]  EN
           1   C
SW   [3    0            6]  COMP
           2   D
           I   E
GND  [4    X            5]  FB
           X
           X
           X
```

DE PACKAGE
(Top View)

DE PART MARKING
"xxxx" Denote Date Code and Lot Identification

RoHS / Pb-free 100% Matte Tin Pin Finish

THERMAL DATA

DE **Plastic SOIC 8-Pin With Exposed Pad**

THERMAL RESISTANCE-JUNCTION TO AMBIENT, θ_{JA}	60°C/W

Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$.
The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system. All of the
above assume no ambient airflow.

FUNCTIONAL PIN DESCRIPTION

Pin	Name	Description
1	BST	Bootstrap pin. A minimum 10nF bootstrap capacitor is connected between the BS pin and SW pin. The voltage across the bootstrap capacitor drives the internal high side NMOS.
2	VIN	Supply input pin. A capacitor should be connected between the VIN pin and GND pin to keep the input voltage constant.
3	SW	Power switch output pin. This pin is connected to the inductor and bootstrap capacitor.
4	GND	Ground.
5	FB	Feedback pin. This pin is connected to an external resistor divider to program the system output voltage. When the FB pin voltage exceeds 20% of the nominal regulation value of 0.925V, the over voltage protection is triggered. When the FB pin voltage is below 0.3V, the oscillator frequency is lowered to realize short circuit protection.
6	COMP	Compensation pin. This pin is the output of the transconductance error amplifier and the input to the current comparator. It is used to compensate the control loop. Connect a series RC network from this pin to GND. In some cases, an additional capacitor from this pin to GND pin is required.
7	EN	Control input pin. Forcing this pin above 2.7V enables the IC. Forcing this pin below 1.1V shuts down the IC. When the IC is in shutdown mode, all functions are disabled to decrease the supply current below 1µA.
8	SS	Soft-start control input pin. SS controls the soft start period. Connect a capacitor from SS to GND to set the soft-start period. A 0.1µF capacitor sets the soft-start period to 9ms. To disable the soft-start feature, leave SS unconnected.

NX7102

Copyright © 2010
Rev.1.6, 2015-02-20

Microsemi
Analog Mixed Signal Group
One Enterprise, Aliso Viejo, CA, 949-380-6100, Fax: 949-215-4996

Page 2

WWW.*Microsemi*.COM

NX7102

Parameter	Symbol	NX7102 Min	NX7102 Typ	NX7102 Max	Units
Input Operating Voltage	VIN	4. 5		18	V
Maximum Output Current	I_{OUTMAX}	3			A
Operating Ambient Temperature	T_A	-40		85	°C

Unless otherwise specified, the following specifications apply for V_{IN} = V_{EN} =12V, V_{OUT} = 5V, T_A = 25°C.

Parameter	Symbol	Test Conditions	NX7102 Min	NX7102 Typ	NX7102 Max	Units
▶ **Operating Current**						
Quiescent Current	I_Q	V_{FB} = 1V		1.25	1.4	mA
Shutdown Current	I_{SHDN}	V_{EN} = 0V		.02	1	µA
▶ **UVLO**						
V_{IN} UVLO Threshold	V_{UVLO}	V_{IN} Rising	3.65	4.00	4.25	V
Hysteresis	V_{HYS}			0.2		V
▶ **Feedback**						
Feedback Voltage	V_{FB}	T_A = -40°C to 85°C	0.907	0.925	0.943	V
Feedback Bias Current	I_{FB}	V_{FB} = 1V	-0.1		0.1	µA
▶ **Oscillator**						
Internal Oscillator Frequency	F_{OSC1}		280	340	400	kHz
Short Circuit Oscillator Frequency	F_{OSC2}			100		kHz
Maximum Duty Cycle	D_{MAX}	V_{FB} = 0.8V		90		%
Minimum Duty Cycle	D_{MIN}	V_{FB} = 1V			0	%
▶ **Error Amplifier**						
Error Amplifier Transconductance	G_{EA}			800		µA/V
Voltage Gain[1]	A_{EA}			400		V/V
▶ **Current Sensing Gain**						
Current Sensing Gain	G_{CS}			5.2		A/V
▶ **Soft-Start**						
Soft-start Current				6		µA
Soft-start Time	T_{SS}	C_{SS} = 0.1µF		15		ms
▶ **Output Stage**						
High-side Switch On Resistance	R_{DSONH}		90	120	150	mΩ
Low-side Switch On Resistance	R_{DSONL}		70	100	130	mΩ
High-side Switch Leakage Current	I_{LEAKH}	VIN = 18V, V_{EN} = 0V, V_{SW} = 0V		0.1	10	µA
High-side Switch Current Limit	I_{LIMH}		4.3	5.5	6.7	A
Low-side Switch Current Limit	I_{LIML}		0.85	1.45	2.05	A
▶ **EN**						
EN shutdown Threshold	V_{ENH}		1.1	1.5	2	V
EN shutdown Threshold Hysteresis	V_{ENL}			350		mV

Copyright © 2010
Rev.1.6, 2015-02-20

Microsemi
Analog Mixed Signal Group
One Enterprise, Aliso Viejo, CA, 949-380-6100, Fax: 949-215-4996
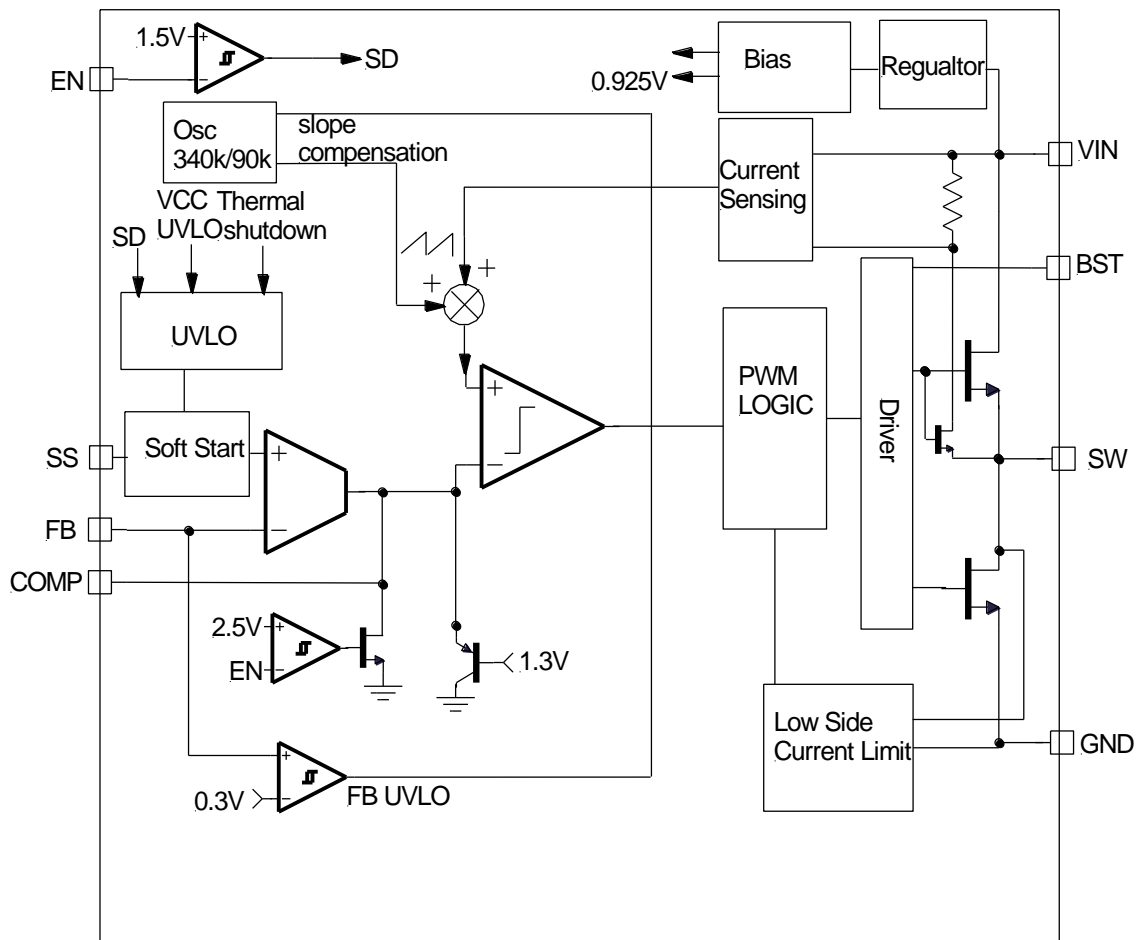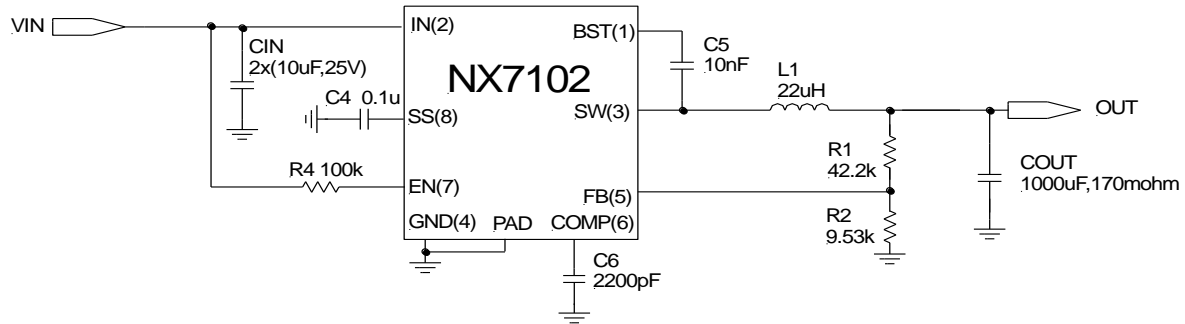
Page 3

ELECTRICAL CHARACTERISTICS (CONT)

Unless otherwise specified, the following specifications apply for $V_{IN} = V_{EN} = 12V$, $V_{OUT} = 5V$, $T_A = 25°C$.
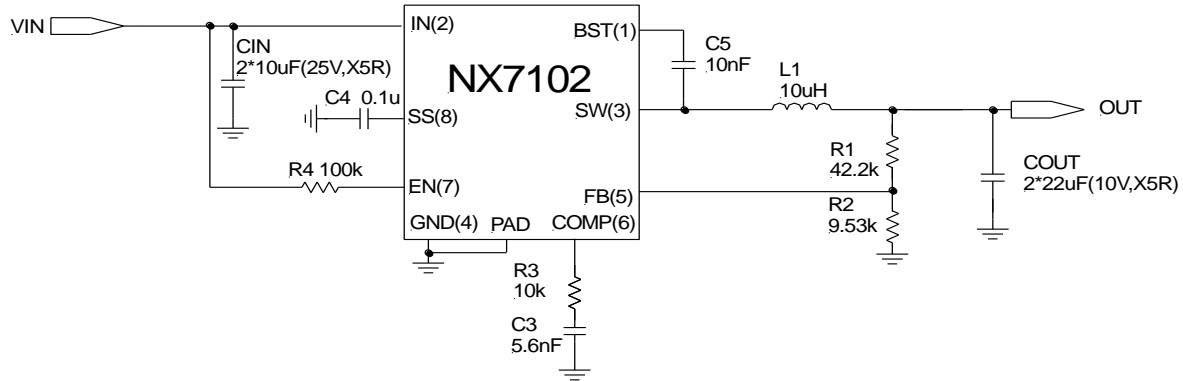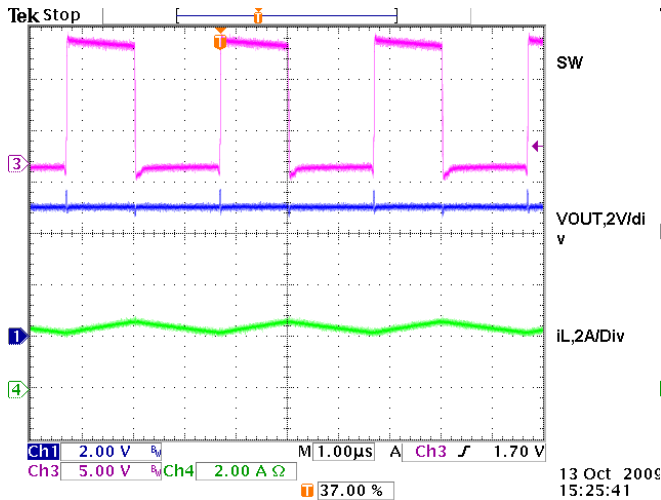
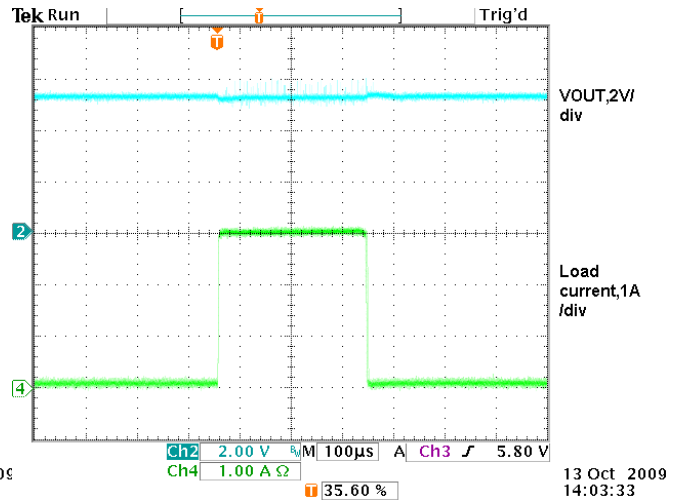| Parameter	Symbol	Test Conditions	NX7102 Min	NX7102 Typ	NX7102 Max	Units
EN Lockout Threshold			2.2	2.5	2.7	
EN Lockout Hysteresis				210		mV
Protection						
Over Voltage Protection Threshold	V_{FBOV}			1.1		V
FB Short Circuit Protection			0.23	0.3	0.41	V
Thermal Shutdown Threshold	T_{OTSD}			160		°C
Thermal Shutdown Hysteresis	T_{HYS}			30		°C

Notes:
1) Guaranteed by design, not tested.

SIMPLIFIED BLOCK DIAGRAM

Figure 2 – Simplified Block Diagram

Copyright © 2010
Rev.1.6, 2015-02-20

Microsemi
Analog Mixed Signal Group
One Enterprise, Aliso Viejo, CA, 949-380-6100, Fax: 949-215-4996

Page 4

NX7102

WWW. *Microsemi***.COM**

APPLICATION CIRCUIT

Figure 3 – 12V Input, 5V Output with Electrolytic Cap

NX7102

Copyright © 2010
Rev.1.6, 2015-02-20

Microsemi
Analog Mixed Signal Group
One Enterprise, Aliso Viejo, CA, 949-380-6100, Fax: 949-215-4996

Page 5

Figure 4 – 12V Input, 5V Output with Ceramic Cap

TYPICAL WAVEFORMS @ 25°C (REFER TO FIGURE 3)

Figure 5. DC Operation at 3A
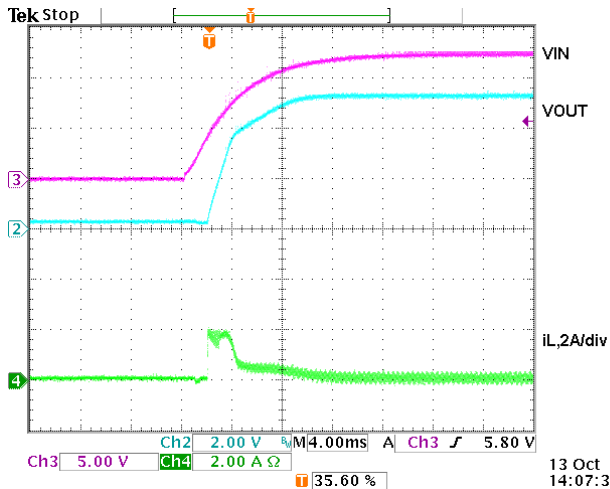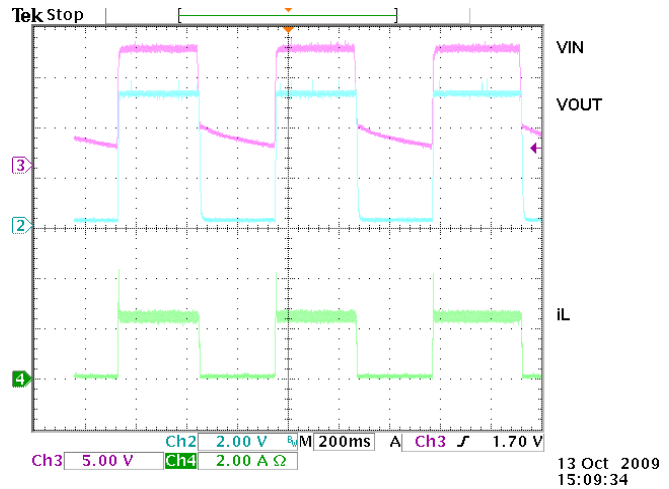

Figure 6. Transient Response

Copyright © 2010
Rev.1.6, 2015-02-20

Microsemi
Analog Mixed Signal Group
One Enterprise, Aliso Viejo, CA, 949-380-6100, Fax: 949-215-4996

Page 6

Figure 7. Start up with no load

Figure 8. Input power recycling

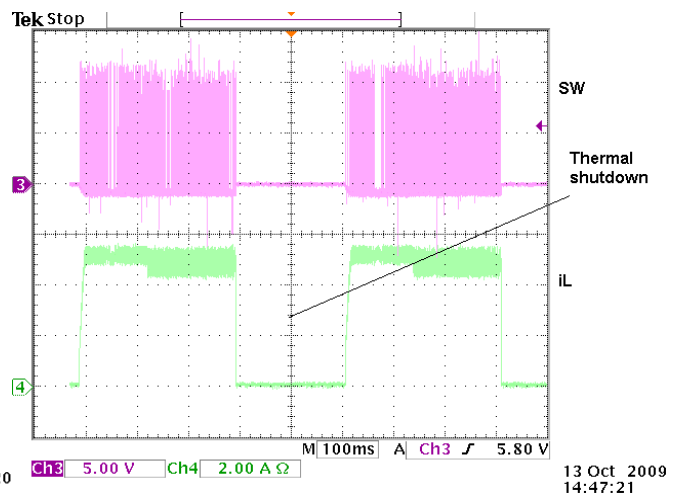TYPICAL WAVEFORMS @ 25°C (REFER TO FIGURE 3)
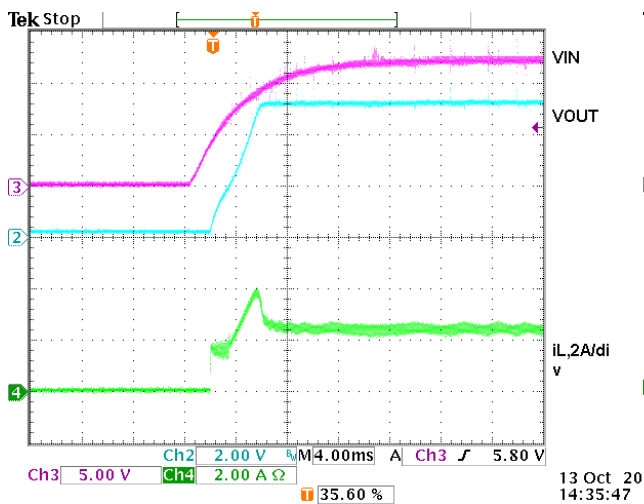
Figure 9. Start into 2A resistive load
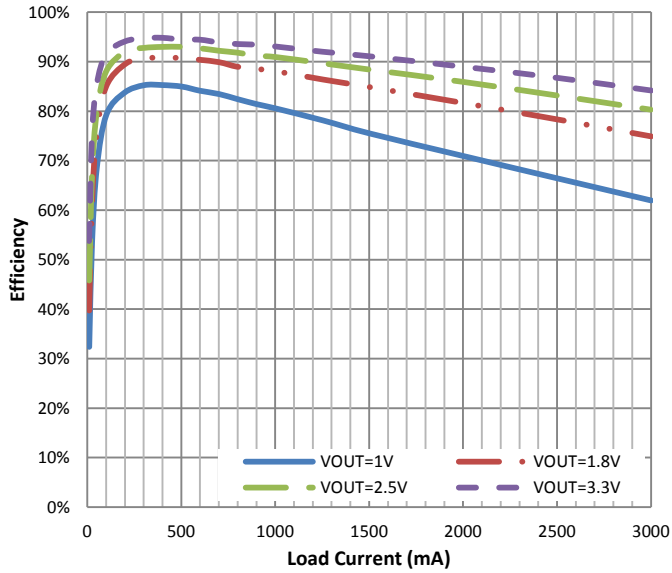

Figure 10. Output short operation

Copyright © 2010
Rev.1.6, 2015-02-20

Microsemi
Analog Mixed Signal Group
One Enterprise, Aliso Viejo, CA, 949-380-6100, Fax: 949-215-4996

Page 7

NX7102

WWW.Microsemi.COM

Figure 11. NX7102 Efficiency VS Load (VIN=5V)
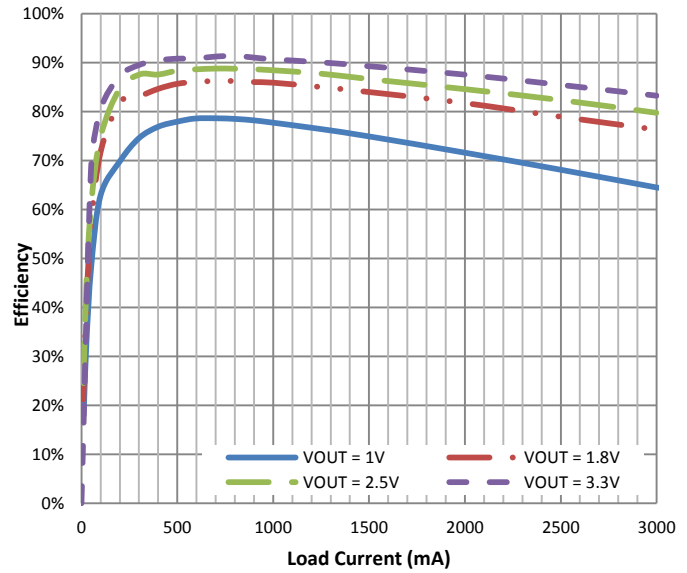
Figure 12. NX7102 Efficiency VS Load (VIN=12V)

WWW.*Microsemi*.COM

THEORY OF OPERATION

DETAIL DESCRIPTION

The NX7102 is a current-mode, PWM synchronous step-down DC-DC converter with 340kHz fixed working frequency. It can convert input voltages from 4. 5V to 18V down to an output voltage as low as 0.925V, and supply up to 3A load current.

The NX7102 has two internal N-MOSFETs to step down the voltage. The inductor current is determined by sensing the internal high-side MOSFET current. The output of current sense amplifier is summed with the slope compensation signal to avoid sub-harmonic oscillation at duty cycles greater than 50%. The combined signal is then compared with the error amplifier output to generate the PWM signal.

Current mode control provides no only fast control loop response but also cycle-by-cycle current limit protection. When load current reaches its maximum output level when the inductor peak current triggers high-side NMOFET current limit. If FB pin voltage drops below 0.3V, the working frequency will be fold back to typically 100kHz to protect chip from run-away.

When FB pin voltage exceeds 1.1V, the over voltage protection is triggered. The high side MOSFET is turned off. Once the OVP condition is gone, the chip will resume the operation following soft-start.

The soft-start time is programmable through the SS pin in order to have desired soft-start time

When the input voltage falls below the UVLO threshold, the Lower Side MOSFET turns to discharge the output capacitance.

NX7102

Copyright © 2010
Rev.1.6, 2015-02-20

Microsemi
Analog Mixed Signal Group
One Enterprise, Aliso Viejo, CA, 949-380-6100, Fax: 949-215-4996

Page 9

APPLICATION INFORMATION

SYMBOL USED IN APPLICATION INFORMATION:

V_{IN} - Input voltage

V_{OUT} - Output voltage

I_{OUT} - Output current

ΔV_{RIPPLE} - Output voltage ripple

F_S - Working frequency

ΔI_{RIPPLE} - Inductor current ripple

DESIGN EXAMPLE

The following is typical application for NX7102, the schematic is figure 1.

$V_{IN} = 12V$

$V_{OUT} = 3.3V$

$I_{OUT} = 3A$

OUTPUT INDUCTOR SELECTION

The selection of inductor value is based on inductor ripple current, power rating, working frequency and efficiency. A larger inductor value normally means smaller ripple current. However if the inductance is chosen too large, it results in slow response and lower efficiency. Usually the ripple current ranges from 20% to 40% of the output current. This is a design freedom which can be determined by the design engineer according to various application requirements. The inductor value can be calculated by using the following equations:

$$L_{OUT} = \frac{V_{IN} \text{ - } V_{OUT}}{\Delta I_{RIPPLE}} \times \frac{V_{OUT}}{V_{IN}} \times \frac{1}{F_S}$$

$$I_{RIPPLE} = k \times I_{OUTPUT} \qquad \text{... (1)}$$

where k is between 0.2 to 0.4.

In this design, k is set at 0.23 and 10µH inductor value is chosen. In order to avoid output oscillation at light load, a minimum 8.2µH inductor is required for all NX7102 application.

OUTPUT CAPACITOR SELECTION

Output capacitor is basically decided by the amount of the output voltage ripple allowed during steady state(DC) load condition as well as specification for the load transient. The optimum design may require a couple of iterations to satisfy both conditions.

The amount of voltage ripple during the DC load condition is determined by equation (2).

$$\Delta V_{RIPPLE} = ESR \times \Delta I_{RIPPLE} + \frac{\Delta I_{RIPPLE}}{8 \times F_S \times C_{OUT}} \qquad \text{... (2)}$$

Where ESR is the output capacitor's equivalent series resistance, C_{OUT} is the value of output capacitor.

Typically when large value capacitors are selected such as Aluminum Electrolytic, POSCAP and OSCON types are used, the amount of the output voltage ripple is dominated by the first term in equation(2) and the second term can be neglected.

If ceramic capacitors are chosen as output capacitors, both terms in equation (2) need to be evaluated to determine the overall ripple. Usually when this type of capacitor is selected, the amount of capacitance per single unit is not sufficient to meet the transient specification, which results in parallel configuration of multiple capacitors.

In this design two 22µF 6.3V X5R ceramic capacitors are chosen as output capacitors.

INPUT CAPACITOR SELECTION

Input capacitors are usually a mix of high frequency ceramic capacitors and bulk capacitors. Ceramic capacitors bypass the high frequency noise, and bulk capacitors supply current to the MOSFETs. Usually 1uF ceramic capacitor is chosen to decouple the high frequency noise. The bulk input capacitors are determined by voltage rating and RMS current rating. The RMS current in the input capacitors can be calculated as:

$$I_{RMS} = I_{OUT} \times \sqrt{D} \times \sqrt{1\text{-}D}$$

$$D = \frac{V_{OUT}}{V_{IN}} \qquad \text{... (3)}$$

In this design two 10uF 25V X5R ceramic capacitors are chosen.

OUTPUT VOLTAGE CALCULATION

Output voltage is set by reference voltage and external voltage divider. The reference voltage is fixed at 0.925V. The divider consists of the ratio of two resistors so that the output voltage applied at the FB pin is 0.925V when the output voltage is at the desired value. The following equation and picture show the relationship between and voltage divider.
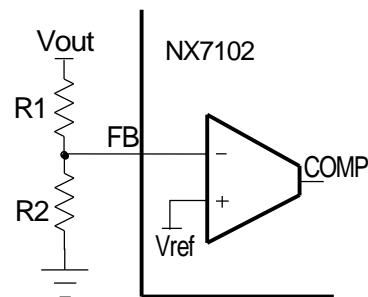

Figure 13 Voltage Divider

The pole P3 set by R3 and C6 is given by the equation (10).

WWW.Microsemi.COM

NX7102

APPLICATION INFORMATION

$$V_{OUT} = V_{REF} \times (1 + \frac{R_1}{R_2}) \qquad \qquad ...(4)$$

In this design choose R1 26.1kΩ, choose R2 10kΩ.

COMPENSATOR DESIGN

The NX7102 uses peak current mode control to provide fast transient and simple compensation. The DC gain of close loop can be estimated by the equation (5).

$$\text{Gain} = A_{EA} \times G_{CS} \times R_{LOAD} \times \frac{V_{FB}}{V_{OUT}} \qquad ...(5)$$

Where A_{EA} is error amplifier voltage gain 560V/V, G_{CS} is current sensing gain 5.2A/V, R_{LOAD} is the load resistor.

The system itself has one pole P1, one zero Z1 and double pole P_{DOUBLE} at half of switching frequency F_S.

The system pole P1 is set by output capacitor and output load resistor. The calculation of this pole is given by the equation (6).

$$F_{P1} = \frac{1}{2 \times \pi \times R_L \times C_{OUT}} \qquad ...(6)$$

The system zero Z1 is set by output capacitor and ESR of output capacitor. The calculation of this zero is given by the equation (7).

$$F_{Z1} = \frac{1}{2 \times \pi \times R_{ESR} \times C_{OUT}} \qquad ...(7)$$

The crossover frequency is recommended to be set at 1/10th of switching frequency. In order to achieve this desired crossover frequency and make system stable, the resistor R3 and the capacitor C3 is needed in typical applications which use ceramic capacitors as output capacitors.

The pole P2 set by output resistance of error amplifier and C3 is given by the equation (8).

$$F_{P2} = \frac{G_{EA}}{2 \times \pi \times A_{EA} \times C_3} \qquad ...(8)$$

Where G_{EA} is error amplifier transconductance 800μA/V.

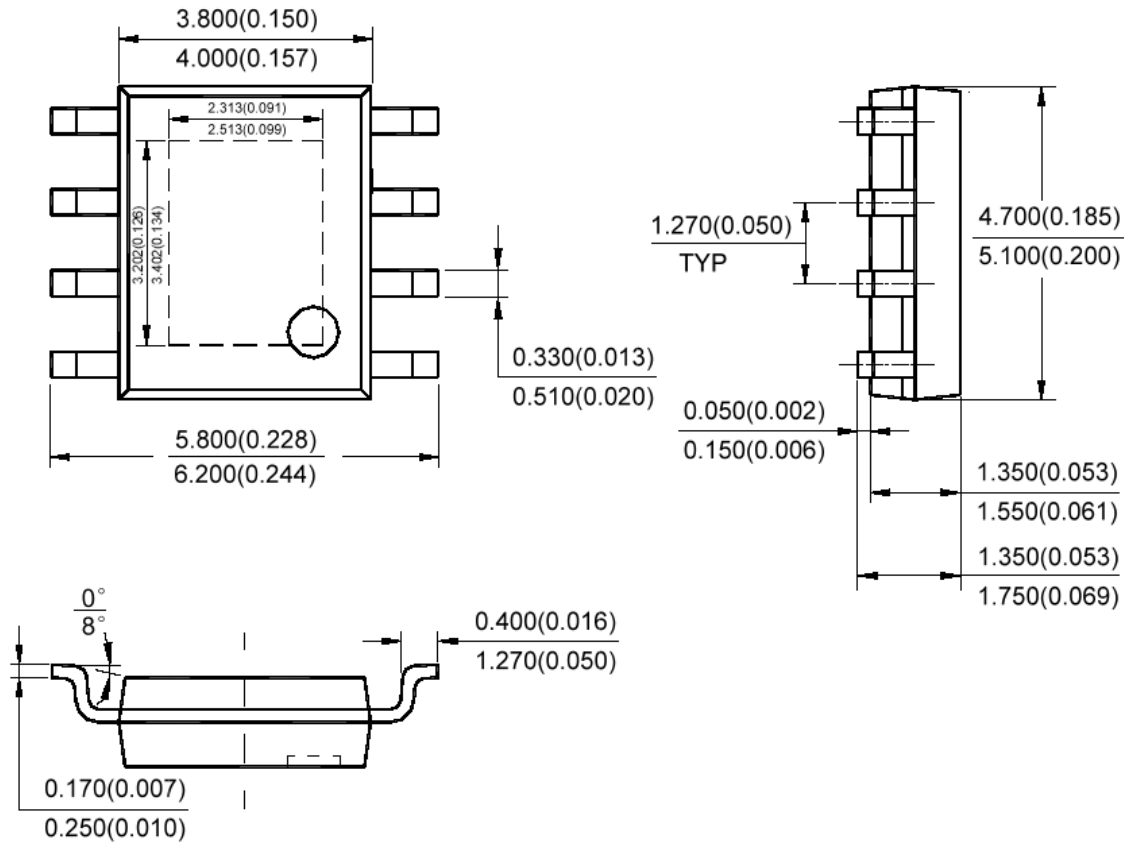The zero Z2 set by R3 and C3 is given by the equation (9).

$$F_{Z2} = \frac{1}{2 \times \pi \times R_3 \times C_3} \qquad ...(9)$$

When Aluminum Electrolytic capacitors are chosen as output capacitors, the ESR zero is much lower and extra capacitor C6 from COMP pin to ground is needed to stabilize the system.

$$F_{P3} = \frac{1}{2 \times \pi \times R_3 \times C_6} \qquad ...(10)$$

The compensation values for typical output voltage application are given in the table below.

V_{OUT}	L	C_{OUT}	R3	C3	C6
1.8V	8.2μH	22μFx2	4.02kΩ	5.6nF	None
2.5V	10μH	22μFx2	5.11kΩ	5.6nF	None
3.3V	10μH	22μFx2	6.49kΩ	5.6nF	None
5V	10μH	22μFx2	10kΩ	5.6nF	None
2.5V	10μH	470μF AL. 30mΩ ESR	40.2kΩ	390pF	220pF
5V	10-15μH	470μF AL. 30mΩ ESR	150kΩ	220pF	120pF

Copyright © 2010
Rev.1.6, 2015-02-20

Microsemi
Analog Mixed Signal Group
One Enterprise, Aliso Viejo, CA, 949-380-6100, Fax: 949-215-4996

Page 11

Microsemi

PACKAGE DIMENSIONS

DE **Plastic SOIC 8 Pin With Exposed Pad**

3.800(0.150)
4.000(0.157)

2.313(0.091)
2.513(0.099)

3.202(0.126)
3.402(0.134)

3.200(0.126)
3.402(0.134)

5.800(0.228)
6.200(0.244)

0.330(0.013)
0.510(0.020)

1.270(0.050)
TYP

4.700(0.185)
5.100(0.200)

0.050(0.002)
0.150(0.006)

1.350(0.053)
1.550(0.061)

1.350(0.053)
1.750(0.069)

0°
8°

0.400(0.016)
1.270(0.050)

0.170(0.007)
0.250(0.010)

Unit: mm(inch)

Copyright © 2010
Rev.1.6, 2015-02-20

Microsemi
Analog Mixed Signal Group
One Enterprise, Aliso Viejo, CA, 949-380-6100, Fax: 949-215-4996

Page 12

NX7102

NOTES

Copyright © 2010
Rev.1.6, 2015-02-20

Microsemi
Analog Mixed Signal Group
One Enterprise, Aliso Viejo, CA, 949-380-6100, Fax: 949-215-4996

Page 13

WWW.*Microsemi*.COM

NX7102